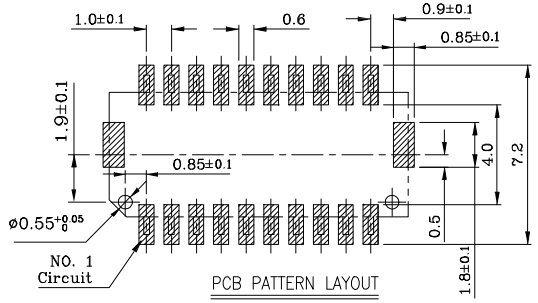
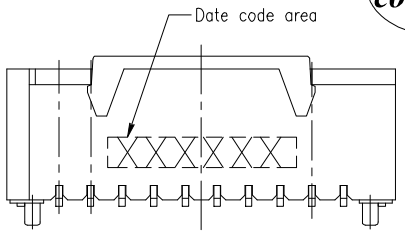
CUSTOMER COPY

RoHS compliant

REVISION DATA				
SYM	ECN	DESCRIPTION	DATE	APPROVED

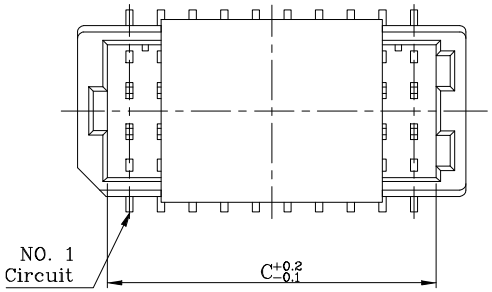


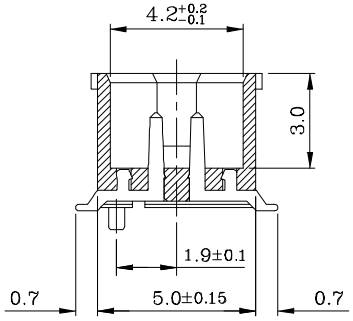
PCB PATTERN LAYOUT



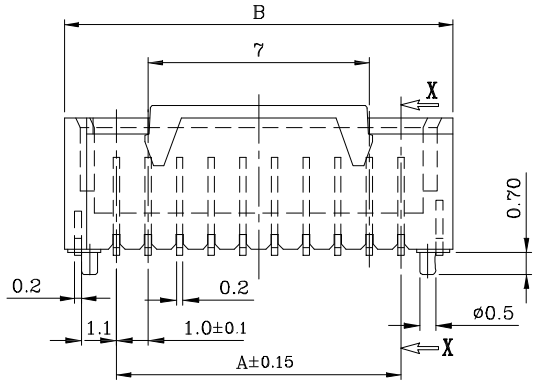
With Date Code

NOTES:
1. MATERIAL:
   1.1 HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR:BLACK OR NATURAL.
   1.2 CONTACT: COPPER ALLOY Gold flash overall
   1.3 FITTING NAIL: COPPER ALLOY
2. REFLOW SOLDER CAPABLE TO 260° C PER ACES SPEC.

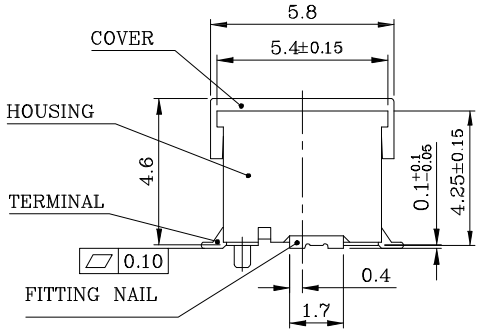




SEC. X-X



Without Date Code



16 ~ 50Pin - Cover

No of pin	Dim A	DimB	Dim C
16	7.0	10.3	8.4
18	8.0	11.3	9.4
20	9.0	12.3	10.4
24	11.0	14.3	12.4
28	13.0	16.3	14.4
30	14.0	17.3	15.4
34	16.0	19.3	17.4
40	19.0	22.3	20.4
50	24.0	27.3	25.4

Ordering Information

W X X X XX - X XX X - 08

Pitch	Versions	Row Option	Position No.	Connector Type	Contact Plating	Insulator Color	Glide No.
C 1.00mm D 1.25mm E 1.50mm F 2.00mm G 2.50mm H 2.54mm	A 180° B 90° D SMT	1 Single Row 2 Dual Row	16 to 50	A: A Type B: B Type	02 Gold Flash	0 Black 1 Natural	01-99

Packing	
1.General	
2.Tape&Reel	
3.Tube	√
4.Tray	
5.Other	

natconn® 广东纳特康电子股份有限公司
GUANGDONG NATCONN ELECTRONIC CO.,LTD

TOLERANCE:	PROJECTION	TITLE:			
ANGLE ±2°	DATE	2013/09/01	JST 1.0 LT WAFER		
X.XXX ±0.05	DRAWN	唐建平	CUSTOMER: N/A	CUSTOMER P/N: N/A	REV: N/A
X.XX ±0.25	CHECKED	张伟	PART NO.:	DRAWING NO.: WCD2XX-AXXX-08	REV: A
X.X ±0.35	APPROVED	冯显东	SIZE: A4	UNIT: mm	SCALE: 1:1
X. ±0.50					SHEET: 1/1